925370-4 - ACTIVE

AMPMODU IV/V TE Internal #: 925370-4 TE Internal Description: MOD IV REC HSG 2X4 POS View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > Wire-to-Board Connector Housings



Number of Positions: 8 Centerline (Pitch): 2.54 mm [.1 in] Termination Method to Wire & Cable: Crimp Number of Rows: 2

Row-to-Row Spacing: 2.54 mm [.1 in ]

### Features

### Product Type Features

Connector & Contact Terminates To	Printed Circuit Board	
Connector Style	Receptacle	
Connector Type	Housing	
Strain Relief	With	
Glow Wire Rating	Standard Part - Not Glow Wire	
Configuration Features		
Number of Positions	8	
Number of Rows	2	
Electrical Characteristics		
Operating Voltage	250 VAC	
Contact Features		
Contact Type	Socket	
Termination Features		
Termination Method to Wire & Cable	Crimp	
Mechanical Attachment		
Mating Retention Type	Lock	
Mating Retention	With	
Housing Features		
Housing Entry Configuration	Both Ends Closed	

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Housing Material	Polyamide 6.6 GF	
Centerline (Pitch)	2.54 mm[.1 in]	
Housing Color	Green	
Dimensions		
	.21 in	
Row-to-Row Spacing	2.54 mm[.1 in]	
Usage Conditions		
Operating Temperature Range	-65 – 105 °C	
Operation/Application		
For Use With	AMPMODU Mod II .025 inch Headers	
Industry Standards		
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	50	

## Product Compliance

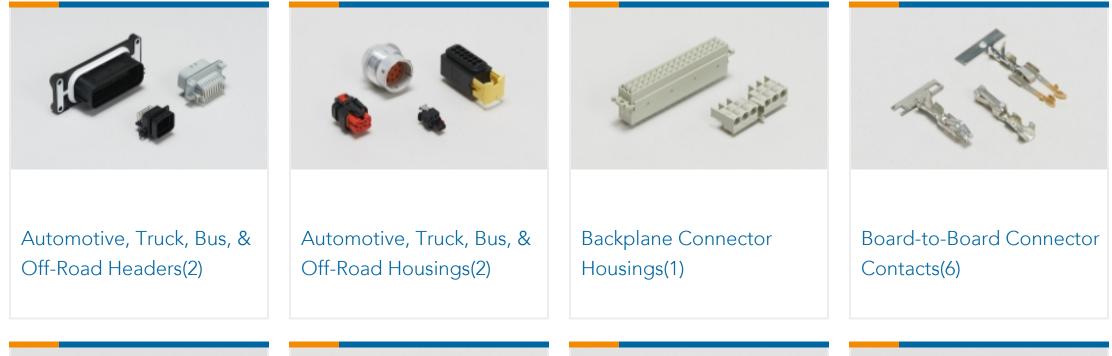
For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUL 2019 (201) Candidate List Declared Against: JAN 2019 (197) Does not contain REACH SVHC
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUL 2019 (201) Candidate List Declared Against: JAN 2019 (197)
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability
Product Compliance Disclaimer	



This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

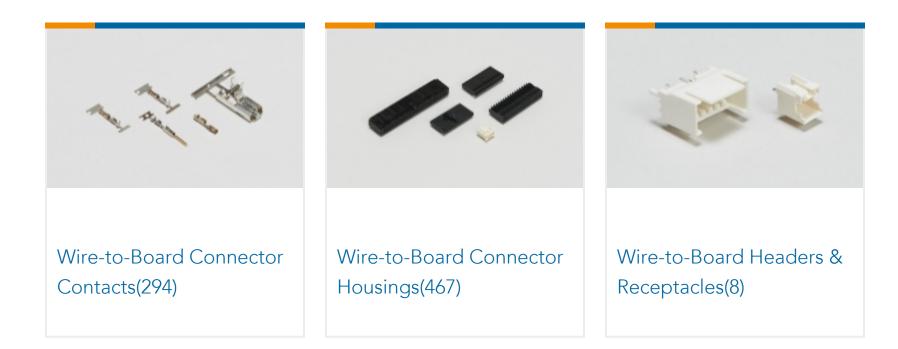
# Also in the Series | AMPMODU IV/V



Board-to-Board Headers & Receptacles(789)	Multiple Configuration PCB Connector Contacts (26)	PCB Connector Covers(15)	PCB Connector Keying(6)
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PCB Connector Mounting (1)	PCB Connector Strain Relief(3)	PCB Latches, Locks & Retainers(10)	Rectangular Connector Housings(3)

MOD IV REC HSG 2X4 POS





# Customers Also Bought



MOD 2 PINHDR 2X04P.	MOD 2 PINHDR 2X04P.	MOD IV REC HSG, 2X8P	KEYING PLUG
SA	And and a second		
S TE			
TE Model / Part #167024-2	TE Model / Part #3-		
MOD-4 REC.CONT.SCP.	1393531-1		
	V23535A3280C201=BKMOD	422	
	FEDER		

### Documents

Product Drawings MOD IV REC HSG 2X4 POS

English

#### **CAD** Files

Customer View Model

#### ENG\_CVM\_CVM\_925370-4\_Z.2d\_dxf.zip

English

3D PDF

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3D

Customer View Model ENG\_CVM\_CVM\_925370-4\_Z.3d\_igs.zip English Customer View Model

ENG\_CVM\_CVM\_925370-4\_Z.3d\_stp.zip

English

Product Specifications

Application Specification

English

Agency Approvals

UL Report

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